SB1316-H

1. Features

- ◆ 1.6mm(L)×0.8mm small size surface mount type
- Thin package of 0.55mm(H) thickness
- ◆ Transparent clear lens optic
- Low power consumption type chip LED

2. Applications

- ♦ LCD backlighting
- Keypad backlighting
- Symbol backlighting
- Front panel indicator lamp

3. Outline Dimensions





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4. Absolute Maximum Ratings

			(Ta=25°C)
Characteristic	Symbol	Rating	Unit
Power dissipation	P _D	68	mW
Forward current	I _F	20	mA
*1 Peak forward current	I_{FP}	50	mA
Reverse voltage	V _R	4	V
Operating temperature range	T _{opr}	-25~80	C
Storage temperature range	T _{stg}	-30~100	Ĉ
*2 Soldering temperature	T _{sol}	240℃ for 5 seconds	

*1.Duty ratio = 1/16, Pulse width = 0.1ms

*2.Recommended reflow soldering temperature profile

- Preheating 150 °C to 185 °C within 120 seconds soldering 240 °C within 10 seconds Gradual cooling (Avoid quenching)





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5. Electrical / Optical Characteristics

						Γ)	$a=25^{\circ}C)$
Characteristic	Syn	nbol	Test Condition	Min	Тур	Мах	Unit
Forward voltage	١	/ _F	I _F = 5mA	2.6	-	3.4	V
*3 Luminous intensity	Iv		I _F = 5mA	5	-	40	mcd
Peak wavelength	λ _P		I _F = 5mA	460	-	480	nm
Spectrum bandwidth	Ĺ	λ_{λ}	I _F = 5mA	-	35	-	nm
Reverse current	I	·R	V _R =4V	-	-	10	uA
*4 Half angle	θ/2	Х	I _F = 5mA	-	±65	-	deg
		Y		-	±70	-	

*3.The test result of $I_{\text{F}}{=}5\text{mA}$ is only for reference

*4. θ /2 is the off-axis angle where the luminous intensity is 1/2 the peak intensity

• V_F / I_V / λ_P / Grade Classification (Ta=25°C)

Test Condition @ I _F =5mA						
Forward Voltage [V]	Luminous Intensity [mcd]	Peak Wavelength [nm]				
1 : 2.6~2.8		a : 460~465				
2 + 2 8 - 2 0	A: 5~9	b . 465470				
2:2.8~3.0	P . 0	D:405~470				
2.20.22	D: 9~22	a : 470 - 475				
3: 3.0~3.2	C + 2240	C: 4/0~4/5				
4 : 3.2~3.4		d : 475~480				

(Each V_F, I_V, λ_P range did not consider a margin. Please refer to ±0.1V of V_F range, ±18% of I_V range, ±1nm of λ_P range as a permitted limit and do not use to combine grade classification. It must be used separately grade classification)

* Recommended Soldering Land Pattern





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6. Characteristic Diagrams









Fig.4 Spectrum Distribution



Fig. 5-2 Radiation Diagram(Y)



